Masanori OCiAWA et al., S.N. 10/518,971 Page 2

## RECEIVED CENTRAL FAX CENTER

Dkr. No. 2710/73654

JUL 2 0 2007

## Listing of Chilms

The following listing of claims will replace all prior versions, and listings, of claims in the subject application:

Claim 1 (currently amended): A bondable sheet comprising a porous sheet into which a precondensate of polyhydric phenol or a precondensate of monohydric phenol and polyhydric phenol is impregnated, and <u>further</u> having powder of a thermosetting resin comprising a <u>novolak</u> type phenolic resin which is meltable by heating, on the surface of said porous sheet.

Claim 2 (currently amended): In A bondable sheet in accordance with claim 1, wherein said precondensate impregnated into said porous sheet is a thermosetting resin.

Claim 3 (cancelled).

Claim 4 (canceled).

Claim 5 (previously presented) A laminated material wherein said bondable sheet of claim 1 is bonded to another sheet member through said powder of said thermosetting resin on the surface of said bondable sheet.

Claim 6 (previously presented) A laminated material wherein said bondable sheet of claim 2 is bonded to another sheet member through said powder of said thermosetting resin on the surface of said bondable sheet.